

Univerza v Ljubljani



Requirements to the detectors

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SuperKEKB open proto-collaboration meeting, March 19-20, 2008

March 19, 2008

SuperKEKB open collaboration meeting

Peter Križan, Ljubljana



Why upgrade the Belle detector? How to upgrade? Subsystems, options How to proceed

•Based on slides shown by Y. Ushiroda at BNM2008 and Belle PAC

•Details of individual subdetectors \rightarrow see the talks later today and tomorrow





Motivation for the detector upgrade

- 1. Need a better performance, better physics sensitivities and operation at higher rates
- 2. Operation under higher background rates





Motivation for the detector upgrade

Need a better performance, better physics sensitivities and operation at higher rates

- better π/K separation for $B \rightarrow \rho \gamma$ decays
- low momentum μ identification \rightarrow s $\mu\mu$ recon. eff.
- hermeticity $\rightarrow v$ "reconstruction"



ı, Ljubljana



Projected luminosity (preliminary)



Conservative scenario – quicker with more money!



Background projection (preliminary)





Beam Background (LoI)





Beam Background (present)



Several to 20 times more background (depending on I_{beam})



Baseline design for the upgrade

One of the possible designs; minimum modification to the Belle structure Comparable or better performance under 20 times more background





Motivation of simulation studies

- Detector design is flexible. A few limitations:
 - Should work under 20 times more background
 - Try to keep the same mechanical structure for the outer detectors (ECL,KLM)
 - Technologically feasible (within a few years)
 - Financially possible
- With these limitations, we wish to have the best detector for future physics analyses
 - When the limitation is tight, we look for a compromise rather than the optimum point.

Use fast and full MC, both tuned with present Belle data



Key points of SVD upgrade





Options we have

- Sensor
 - Pixels (SOI, DEPFET)
 - DSSD (striplet/normal)
- Readout chip
 - APV25
 - $t_p = 50$ ns, pipelined, weak at high C_d
 - VA1TA (currently used)
 - $t_p = 800$ ns, hold & readout
 - Own ASIC





Open questions:

8.5mm

- 1. Inner radius
- 2. Outer radius
- 3. Material budget
- 4. Readout pitch of outer layers
- 5. Slant angle



Baseline Design (LoI '04)





- T=0 option (2012) for $L = \sim 10^{35}$
 - Keep beampipe radius 1.5cm same as current
 - Current SVD configuration + 2 outer layers
 - Improve Ks efficiency. Replace CDC inner layers
 - Similar design DSSD can be used
 - Fast shaping(~50ns) + time slice
- Further upgrade for L $>10^{35}$
 - Smaller beampipe radius (r =1cm or less)
 - Innermost (thin) pixel layers
 - Improve impact parameter resolution

Pixels could also come on day 1 if ready!



Outer layers and outer radius



• Long sensor \rightarrow large capacitance \rightarrow big noise



Matching efficiency for Ks



$K_{\rm S}$ daughter tracks affected by S/N degradation Loose 20% events with 4 times worse S/N



Chip on sensor?



(Drawings not to scale)

To use APV25 chips for the outer layers, they have to be put on top of the sensors



T. Kawasaki

- 1. Material okay?
- 2. Cooling possible?
- 3. Stable?



Material impact on vertex resolution



| | π ⁺ π ⁻ (31μm) | J/ ψ K _S (36μm) | D + D - (43μm) | Κ[*](K_Sπ⁰) γ (128μm) | |
|---|--------------------------------------|--|------------------------------|---|--|
| 2×ρ for SVD,CDC | 6% | 11% | 19% | | |
| 2×ρ for SVD | 6% | 11% | 21% | | |
| 2×ρ for SVD lyr1,2 | 6% | 11% | 19% | | |
| 2×ρ for SVD lyr3,4 | 0% | 0% | 0% | | |
| 2×p for SVD lyr3,4 + cooling tube | 0% | 0% | 0% | 7% | |
| | No degradation | | | | |

No degradation

•No problem to increase the material in outer layers for 'normal' vertex reconstruction.

•Dilutes the merit of having a larger volume for $\ensuremath{\mathsf{K}_{\mathsf{S}}}$





Other MC results



•Momentum resolution: is not affected by material in SVD



Key points of CDC upgrade





CDC main parameters

| | Present | Upgrade |
|--|-------------|-------------|
| Radius of inner boundary (mm) | 77 | 160 |
| Radius of outer boundary (mm) | 880 | 1140 |
| Radius of inner most sense wire (mm) | 88 | 172 |
| Radius of outer most sense wire (mm) | 863 | 1120 |
| Number of layers | 50 | 58 |
| Number of sense wires | 8400 | 15104 |
| Effective length of dE/dx measurement (mm) | 752 | 978 |
| Gas | $He-C_2H_6$ | $He-C_2H_6$ |
| Diameter of sense wire (µm) | 30 | 30 |



 $D^*D^*(D^* \to D\pi_s, D \to K3\pi)$

Many low momentum tracks, the hardest case for tracking

Gain in reconstruction efficiency of $B \rightarrow D^*D^*$

| Tracker BKG | Belle | Software update | +SVD tracker |
|----------------|-----------------|--------------------|-----------------|
| Belle | ε =4.3% | ε =7.1% | ε =11.9% |
| | 0% (definition) | +65% | +177% |
| ×5BG | | ε =6.3% | ε =11.2% |
| | | +47% | +160% |
| × 20 BG | | ε =3.8% | ε =8.8% |
| | | -12% | +105% |

Excellent with help of SVD



Key points of PID upgrade





PID upgrade





Barrel PID





Imaging Cherenkov counter with quartz bars as radiators.

Image read-out: •Time-Of-Propagation (TOP) •Focusing DIRC •Imaging TOP



Similar to DIRC, but instead of two coordinates after a standoff box measure at the bar end:

- One (or two coordinates) with a few mm precision
- Time-of-arrival
- → Excellent time resolution < ~40ps required for single photons in 1.5T B field



TOP image



Pattern in the coordinate-time space ('ring') of a pion hitting a quartz bar with ~80 MAPMT channels

Time distribution of signals recorded by one of the PMT channels: different for π and K



• Detector type

– <u>3-readout type</u>

- Optimized propagation length
- Simple configuration
- Simple ring image

– Focusing type

- Correct chromaticity
- 2/3 of PMTs
 - Cost
 - Easy to replace PMTs because of no middle PMT
- Complicated ring image
 - Need a new reconstruction method
 - May need more sim. study



K. Inami





Possible configuration

- Photo-cathode of MCP-PMT
 - Multi-alkali
 - Almost established production
 - Enough lifetime (with Al layer)
 - GaAsP
 - Better efficiency at longer wavelength→less dispersion
 - Need more production R&D and lifetime test
 - Multi-alkali without protection layer on MCP
 - Better efficiency (x1.6)
 - Almost established production, but need some modification to improve lifetime (3-layer MCP, lower gain etc.)



K. Inami





• K/ π separation power

2997/20/15-20 BCH07

- GaAsP photo-cathode(+>400µm filter), CE=36%







- Similar to BaBar DIRC
 Need more realistic design study by simulation
 - Newsy appendix for support structure
- Narrow space for support structure
 - Quartz, Al wall, (Al honeycomb holder)
- Gaps $ir\phi \rightarrow \sim 10\%$ dead space

~1cm weak region from bar edge



Talk by K. Inami







Talk by K. Inami

- Possible overlapped layout
 - Need 50cm wide quartz bars (← 40cm-width)
 - R1080 of internal radius (\leftarrow R1150 for no overlap)









Interference with calorimeter:

- influence on three photons from $B \rightarrow K^*(K_S \pi^0) \gamma \rightarrow$ MC check \rightarrow no difference between the two TOP configurations
- single photons and π^0





Alternatives: focusing DIRC and imaging TOP





LR

LD



Proximity focusing RICH in the forward region

rat

Requirements and constraints:

- ~ 5 σ K/ π separation @ 1-4 GeV/c
- operation in magnetic field 1.5T
- limited available space ~250 mm





- n = 1.05

- $\theta_c(\pi) \sim 308 \text{ mrad} @ 4 \text{ GeV/c}$
- $-\theta_{c}(\pi)-\theta_{c}(K) \sim 23 \text{ mrad}$
- pion threshold 0.44 GeV/c,
- kaon threshold 1.54 GeV/c
- time-of-flight difference (2m): $t(K) - t(\pi)$ = 180 ps @ 2 GeV/c = 45 ps @ 4 GeV/c


Photon detector options for 1.5T

- HAPD
 - Working samples, being tested on the bench and in the beam
 - Stability, ageing? Need more production R&D
- MCP-PMT
 - Excellent beam and bench performance
 - Good TTS for TOF information
 - <20ps TOF resolution (low momentum PID)
 - Need lifetime estimation
- SiPM (GAPD)
 - Good stability, enough gain and TTS
 - Need large effective area or light guide to make ~5x5mm² pads
 - Need gated readout because of high dark count (<~MHz)
 - Radiation hardness?







Barrel – endcap transition region

Need to minimize dead space at the transition region

- TOP needs PMT region at bar end.→ can be covered with the aerogel RICH
- To detect Cherenkov light emitted to the outside, use planar *mirrors*

MC study: efficiency recovered



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Key points of ECL upgrade









Removal of ACC helps. No big worry

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•Waveform sampling & fitting
•CsI(TI) → pure CsI for end caps



Partial replacement with pure CsI:

•768 (+green)

•480 (red only)

backward

forward

•1152 (+blue)

•2112 (+pink)

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Pure CsI crystals

| | Price of crystal | Light yield | Uniformity | Radiation hardness |
|--------------|---------------------|-------------|------------|-----------------------|
| Kharkov | 6k\$ (2004) | 80 p.e./MeV | <10% | Good |
| SICCAS | 4k\$ (2006) | 30 p.e./MeV | 10-20% | Good |
| Saint Gobain | 8k\$ (2006) | 130 p.e/MeV | <10% | Good |

MC study of the impact of using pure CsI on the sample of fully reconstructed B mesons:

- Full backward and forward endcap (2112 crystals): eff +5%, background -7%
- Visible effect if >1000 replaced crystals

Need MC studies of the effect also on other channels.



Pure CsI – impact 2



(*) Reduce material not taken into account for this study

SuperKEKB open collaboration meeting





Scintillator KLM set up

- Two independent (x and y) layers in one superlayer made of orthogonal strips with WLS read out
- Photodetector = avalanche photodiode in Geiger mode (GAPD, SiPM)
- ~120 strips in one 90° sector (max L=280cm, w=25mm)
- ~30000 read out channels
- Geometrical acceptance > 99%



<u>Mirror</u> 3M (above groove & at fiber end)





Other issues

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- \bullet Toy MC results considering ${\bigtriangleup t}$ resolution and geometrical acceptance.
- Geometrical acceptance is assumed to be same as in the current Belle detector.









Configurations & Assumptions







Detecting capability: Muon only. Charged tracks. Charged tracks + photon

Assuming an uniform 95% detecting efficiency for now

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First Order Study: Geant4 Simulations

Minimum hypothesis & target: A forward <u>TRACKER</u> for improving detector acceptance. (No direct contribution to main analysis, but as a veto detector) Reject the prompt tracks from IP for the full-reconstruction analyses. No space so far, so it's better to demonstrate the capability before any other works: ~4cm





Powerful if it works



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Still to be studied...

- Readout pitch of SVD outer layers
- If 10% hole in TOP is acceptable or not
- Impact of partial upgrade with pure CsI more modes
- Very forward detector with realistic configuration, realistic background conditions
- Tau decays more modes
- K_L reconstruction efficiency (with single layer)







"effective" background with new hardware

| | Method | Reduction factor | bkg |
|-------|--------------------------------|-------------------------|------------|
| SVD | Shorter t _p | 50/800 = 1/16 | 0 ~ 1 |
| CDC | Smaller cell | <2/3 | 4 ~ 13 (*) |
| PID | Brand new device | Good enough | 0 ~ 1 |
| B-ECL | Waveform fitting | 1/7 | 1 ~ 2 |
| E-ECL | Pure CsI (shorter τ) | 1/200 | 0 ~ 1 |
| KLM | Faster detector, finer segment | Under control | 0 ~ 1 |

(*) Covered by software for CDC

 \rightarrow We know how to handle high backgrounds



Overall schedule (back calculation)

| | year month | 1 2 3 4 | 2006 2009 2009 2009 5 6 7 8 9 10 11 12 1 2 3 4 5 6 7 8 | 9 10 11 12 1 2 3 4 5 6 7 8 9 10 11 12 1 2 3 4 5 6 7 8 9 10 11 12 1 2 3 4 5 6 7 8 9 10 11 12 |
|------------|---|--------------------------------------|---|---|
| SVD outer | Geometrical Boundary Fix Mechanical Design Fix Technical Design Fix Construction & Test | by Feb.01, 2009 by Dec.31, 2009 | Start En | d-ring production |
| SVD inner | Geometrical Boundary Fix Mechanical Design Fix Technical Design Fix Construction & Test | Detector | Decision | for what |
| SVD CDC | Installation Geometrical Design Fix Mechanical Design Fix | | Date | |
| ТОР | Technical Design Fix Construction & Test Installation Geometrical Design Fix | SVD | Mid 2009 | End-ring and beam pipe |
| | Mechanical Design Fix Technical Design Fix Construction & Test Installation | CDC | Sep. 2009 | Chamber production (end plate) |
| A-RICH | Geometrical Design Fix Mechanical Design Fix Technical Design Fix Construction & Test Assemble | ТОР | May 2009 | Quartz bar production |
| ECL | Installation Geometrical Design Fix Mechanical Design Fix Technical Design Fix | ARICH | Mar. 2009 | Photon detector production |
| KLM EndCa | Construction & Test Assemble Installation ap Geometrical Design Fix | ECL | Mar. 2009 | Crystal and PMT |
| KLM Barrel | Technical Design Fix Construction & Test Installation Geometrical Design Fix | E-KLM | Sep. 2009 | Sciptillator modulo production |
| | Technical Design Fix Construction & Test Installation | B-KLM | Mid 2010 | |
| STR | Barrel Design Fix Endcap Design Fix Construction & Test Installation (KLM) Installation (Endcap) Installation (Barrel) Global Cosmic Ray Test Roll in Beam On | by Apr. 20.2010 A 6 months by Apr | in March 2009 (E | ECL, A-RICH) to be ready in early 2013 |
| | year month | 1 2 3 4 | 2008 2009 5 6 7 8 9 10 11 1 2 3 4 5 6 7 8 | 2010 2011 2012 9 10 11 12 1 2 3 4 5 6 7 8 9 10 11 12 1 2 3 4 5 6 7 8 9 10 11 12 1 2 3 4 5 6 7 8 9 10 11 12 1 2 3 4 5 6 7 8 9 10 11 12 1 2 3 4 5 6 7 8 9 10 11 12 1 2 3 4 5 6 7 8 9 10 11 12 1 2 3 4 5 6 7 8 9 10 11 12 1 2 3 4 5 6 7 8 9 10 11 12 1 2 3 4 5 6 7 8 9 10 11 12 1 2 3 4 5 6 7 8 9 10 11 12 1 2 3 4 5 6 |

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Overall schedule





Summary

- Belle+KEKB have proven to be an excellent tool for flavour physics; reliable long term operation, constant improvements of the performance.
- Major upgrade in 2009-12 \rightarrow Super B factory
- More details on components and current options later today and tomorrow.
- Essentially a new project, all components have to be replaced, plans exist, nothing is frozen...
- If you have a bright idea what to add/change, do not miss the chance to propose it!
- Ongoing detector R+D has to be wrapped up soon...







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SVD possible options

Option 0 Option 1 Option 2 'Cheap and Nasty' 'Super' 'Baseline' 1.5cm BP 1.5cm BP 1cm BP 2lyr APV + 2lyr VA Pixel + 4lyr APV 6lyr APV Readout dead time Pipelined; dead time free, no peak (27→)15%@10kHz hold L1 30% better IP K_S vtx +20~30%, Hold dead time = resolution slow tracking +20% 10%@33kHz L0 Not in time Good performance Otherwise fine in in the first few performance years No gain in K_S vtx Option 1 +1.5M\$ 0.3M\$ 4M\$ or 5M\$ Superice open conavoration meeting 1101CH 17, 2000 FCLCE INIZALI, LJUDIJALIA



SVD Schedule (first half)

| | | Calender Year | 2007 | | 20 | 800 | | | 2 | 009 | |
|---------------------|-------------------------------------|-------------------------|------|---|-----|------|-------------|-----|------|-----|-----|
| | | I:Jan-Mar, II:Apr-Jun | IV | I | II | III | IV | I | II | III | IV |
| Items | | III:Aug-Oct, IV:Nov-Dec | | | | | | | | | |
| Overall | | | | | | | | | | | |
| | MC study | ~12/31/2008 | | | | | | | | | |
| | Decide Outer Radius | 2/1/2009 | | | | | | | | | |
| | (CDC design start) | 3/1/2009 | | | | | | | | | |
| | Decide Inner radius&Sensor Opt | 6/30/2009 | | | | 1 | | | | | |
| | EndRing design&Production | 7/1/2009-6/30/2011 | | | | 1 | | | | | |
| | Beampipe design&production | 11/1/2009-11/15/2011 | | | | | | | | | |
| | | | | | | | | | | | |
| Innerlayer | Decide Inner radius&Sensor Opt | 6/30/2009 | | | | | | | | | |
| SOIPIX/CAPS | R&D | ~6/30/2010 | | | | | | | | | |
| | Production | 4/1/2009-2/28/2011 | | | | | | | | | |
| | Assemble | 3/1-5/31/2011 | | | | | | | | | |
| | Test(sensor module) | 6/1-6/30/2011 | | | | | | | | | |
| | Mounting | 7/1-7/31/2011 | | | | | | | | | |
| Striplet+APV25 | R&D | ~3/31/2010 | | | | | | | | | |
| | Production | 4/1/2010-3/31/2011 | | | | | | | | | |
| | Assemble | 4/1-6/30/2011 | | | | | | | | | |
| | Mounting | 7/1-7/31/2011 | | | | 1 | | | | | |
| SVD3(DSSD+APV25 | Assemble | 5/1-7/14/2011 | | | | | | | | | |
| | Mounting | 7/15-7/31/2011 | | | | | | | | | |
| | Test(Total Innerlayer) | 8/1-8/31/2011 | | | | | | | | | |
| OuterLayer | Decide OuterLayer technology Option | 12/31/2009 | | | | | | | | | |
| DSSD by India/Korea | DSSD R&D(incl. Test production) | ~12/31/2010 | | | | | | | | | |
| - | DSSD Production | 8/1/2009-2/28/2011 | | | | | | | | | |
| Other company | DSSD Test production | 4/1/2010-12/31/2010 | | | | 1 | | | | | |
| | DSSD Evaluation | 1/1/2010-2/28/2010 | | | | | | | | | |
| | DSSD Production | 3/1/2010-2/28/2011 | | | | | | | | | |
| APV25 readout | Chip delivery | 12/1/2009-1/31/2011 | | | | 1 | | | | | |
| Develop ASIC | FE chip R&D(incl. Test production) | ~2/28/2010 | | | | | | | | | |
| | Production | 3/1/2009-2/28/2011 | | | | | | | | | |
| | Ladder Assemble | 3/1-8/31/2011 | | | | 1 | | | | | |
| | Mounting | 9/1-10/31/2011 | | | | | | | | | |
| | Test(Total Outerlayer) | 11/1-11/15/2011 | | | | | | | | | |
| Comissioning | | Ī | | | | 1 | 4.10 | | | | 40 |
| | SVD Assemble(+Beampipe) | 11/15-11/30/2011 | | | 0-5 | stai | rt-I | n−e | ICI: | 21 | J12 |
| | System test in CleanRoom | 12/1/2011-2/28/2012 | + | | | 1 | | | | 1 | 1 |
| | Install | 3/1-5/30/2012 | | | | | | | | | |
| | Cosmic test | 6/1-7/31/2012 | + | | | | | | | | |
| | Boll-in | 8/1/2012 | | | | De | SIO | nc | lec | ISI | on |





Small cell chamber + new readout (ASD)

Current chamber cannot last for long (dark current increases even without beam)

Background reduction into $\sim 2/3$

Chamber 1.8M\$ Frontend electronics 1.5M\$ (Backend 0.3M\$) Total 3.3M\$

Inner/outer radii can be adjusted to other detectors (SVD/PID)

No other option

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S. Uno





CDC Schedule

| | CY | 2009 | | | | 2010 | | | | 2011 | | | | 2012 | | | |
|-------------------------------|----------------------|------|----|-----|----|------|----|-----|----|------|----|-----|----|------|----|-----|----|
| Items | | Ι | II | III | IV |
| Fixing outer radious | 2009/3/1 | | | | | | | | | | | | | | | | |
| Wire configuration design | 2009/3/1-2009/3/31 | | | | | | | | | | | | | | | | |
| Final check using simulation | 2009/3/1-2009/4/30 | | | | | | | | | | | | | | | | |
| Endplate design | 2009/3/1-2009/4/30 | | | | | | | | | | | | | | | | |
| Endplate bidding | 2009/6/1 | | | | | | | | | | | | | | | | |
| Endplate machining | 2009/7/1-2009/12/31 | | | | | | | | | | | | | | | | |
| Drilling | 2010/1/1-2010/6/30 | | | | | | | | | | | | | | | | |
| Assembling of Endplates | 2010/7/1-2010/7/31 | | | | | | | | | | | | | | | | |
| Wire stringing | 2010/8/1-2011/3/31 | | | | | | | | | | | | | | | | |
| Tension measurement | 2011/4/1-2011/4/30 | | | | | | | | | | | | | | | | |
| Insertion of outer cylinder | 2011/5/1-2011/5/2 | | | | | | | | | | | | | | | | |
| Insertion of inner part | 2011/5/3-2011/5/4 | | | | | | | | | | | | | | | | |
| Tension measurement | 2011/5/5-2011/5/31 | | | | | | | | | | | | | | | | |
| Gas leak test | 2011/6/1-2011/8/31 | | | | | | | | | | | | | | | | |
| HV cabling | 2011/9/1-2011/9/10 | | | | | | | | | | | | | | | | |
| HV test | 2011/9/11-2011/9/30 | | | | | | | | | | | | | | | | |
| Signal cabling | 2011/10/1-2011/10/30 | | | | | | | | | | | | | | | | |
| Preamp + Cooling water | 2011/11/1-2011/11/31 | | | | | | | | | | | | | | | | |
| Cosmic ray Test at clean room | 2011/12/1-2012/1/31 | | | | | | | | | | | | | | | | |
| Installation of CDC & Test | 2012/2/1-2012/2/28 | | | | | | | | | | | | | | | | |
| Cosmic ray test on 1.5Tesla | 2012/4/1-2012/6/30 | | | | | | | | | | | | | | | | |
| Roll in | 2012/8/1 | | | | | | | | | | | | | | | | |
| Beam on | 2012/10/1 | | | | | | | | | | | | | | | | |

To start in Oct. 2012

Inner and outer radii should be determined by March 2009

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K. Inami TOP Schedule (first half)



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A-RICH Schedule (first half)

| 1 2 3 4 5 6 7 8 9 10 11 12 3 4 5 6 7 8 9 10 11 12 3 4 5 6 7 8 9 10 11 12 1 2 3 4 5 6 7 8 9 10 11 12 1 2 3 4 5 6 7 8 9 10 11 12 1 2 3 4 5 6 7 8 9 10 11 12 1 2 3 4 5 6 7 8 9 10 11 12 1 2 3 4 5 6 7 8 9 10 11 12 1 2 3 4 5 6 7 8 9 10 11 12 1 2 3 4 5 6 7 8 12 1 1 1 1 <t< th=""><th>08</th><th></th><th></th><th></th><th></th><th></th><th></th><th></th><th></th><th></th><th>2009</th><th></th><th></th><th></th><th></th><th></th><th></th><th></th><th></th><th></th><th></th><th></th><th>2010</th><th></th><th></th><th></th></t<> | 08 | | | | | | | | | | 2009 | | | | | | | | | | | | 2010 | | | |
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| D evaluation bidding photon detector decision bidding photon detector test photon dete | bear | n test | | _ | | | \rightarrow | | | _ | photo | n de | tector | r produ | iction | | | | | | | | | | | |
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| Image: state of the state | | | | | | | | | | | ASIC | SA0 | 2 proc | luctior | n & tes | st | | | | ASIC | chip p | orodu | ction | | | |
| Image: Second | | | | | | | \rightarrow | | | | | | | | | | | | | | | | | | | |
| readout board / readout / readout board / readout / readout board / readout / | | | | - | | | + | | | _ | | | | modu | la daa | irro(U | V/rook | dout / | biog | o ord) | | | | | _ | |
| hanical structure design | | | | | | | + | | | | | | | mout | le des | ign(II | v/reat | uout/ | Jids I | soard) | | | | | read | out boar |
| Image: state of the state | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Image: start in the start | | | | | | | \rightarrow | | | _ | | | | | | | | | | | | | | | | |
| hanical structure design | | | | _ | | | -+ | | | _ | | | | | | | | | | | | | | | LIV. | weters a |
| hanical structure design | | | | | | | - | | | _ | | | | | | | | | | | | | | | | system p |
| Image: state of the state | | | | | | | | | | | | | | | | | | | | | | | | | | |
| backend readout design | | | | | | | | | | | | | | | | | | | | | | | | | | |
| hanical structure design | | | | _ | | | \rightarrow | | | _ | backe | end r | eadou | t desig | (n | | | | | | | | | | | |
| hanical structure design | | | | | | | - | | | - | | | | | | | | | | | | | | | back | end read |
| Image: state in the state | | | | | | | | | | | | | | | | | | | | | | | | | | |
| hanical structure design | | | | | | | | | | | | | | | | | | | | | | | | | | |
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| hanical structure design aerogel design study 1/12 mockup design 1/12 mockup production 0-start-in-Oct-2012 test & design feedback | | 1 | | | | | + | | | | | | | | | | | | | | | | | | - | |
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| 0-start-in-Oct. 2012 | | | | | (10 | | يلب | | | | | | | <u> </u> | | | | | | | | | | | | |
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| Decision of photon detector in October 2008 | | | | | | | | 512 | | | | Υ | Л | | ЛТ_ | u | | | | | T | | | | | 500 |
| Decision of photon detector in October 2008 | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Decision of photon detector in October 2008 | | | | | | | — | | | | | | | | | | | | | | | | | | | |
| Decision of photon detector in October 2008 | | | | | | | | | | - | | | | | | | | | | | | | | | | |
| Decision of photon detector in October 2008 | | | | | | | | | <u>с</u> | 1 | | 1 | | | П | | 1 | п | | | <u>г</u> | 1 | | | <u></u> Г | |

March 19, MBOFE CELEIII SIIa Dayn r exting CELEIII, Ljubljana



Time-of-flight measurement

Time-of-flight with Cherenkov photons from aerogel radiator and PMT window



\rightarrow can positively identify kaons bellow Cherenkov threshold in aerogel (1.5 GeV)

\rightarrow a fast photon detector is an advantage



Beam tests





\rightarrow This photon detector does not work in magnetic field...

Peter Križan, Ljubljana



Beam tests of Burle MCP PMT





Tested in pion beam combination with multi-anode PMTs. →Stable operation, very good performance

Results:

- • σ_9 ~13 mrad (single cluster)
- number of clusters per track N~ 4.5
- $\sigma_9 \sim 6$ mrad (per track)
- • \rightarrow ~ 4 $\sigma \pi/K$ separation at 4 GeV/c

To do list:

 •improve collection efficiency and active area fraction → higher
 number of det. photons → done
 •aging study



MCP-PMT timing properties

Bench tests with pico-second laser

Time resolution as a function of the number of detected photons \rightarrow

Additional bench tests needed: study detailed timing properties and cross-talk.

Determine their influence on the

- position resolution and
- time resolution

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Photon detector candidate: H(A)PD





HAPD bench tests

ADC distribution of HAPD

- With Maximum bias voltage
- -8.5 kV high voltage
- 1 p.e. level light from LED

Clear separation between pedestal and 1 p.e. peak!!



| channel | bias [V] 1 | bombard- ment gain* | total gain | avalanche gain | S/N |
|----------|---------------|------------------------|---------------|-------------------|------|
| chipA-22 | 331 | 1600 | 32000 | 20 | 8.8 |
| chipB-29 | 331 | 1750 | 26000 | 15 | 8.4 |
| chipC-22 | 337 | 1600 | 60000 | 37 | 15.1 |
| chipD-22 | 343 | 1650 | 67000 | 42 | 13.4 |
| *=meas | sured b | y Hamamat | su | | |

- All the four chips show good performance.
- avalanche gain depends on (max.) bias voltage.





SiPMs as photon detectors?

SiPM is an array of APDs operating in Geiger mode. Characteristics:

- low operation voltage ~ 10-100 V
- gain ~ 10⁶
- peak PDE up to 65%(@400nm)
 - PDE = QE x ε_{geiger} x ε_{geo}
- ε_{geo} dead space between the cells
- time resolution ~ 100 ps
- works in high magnetic field
- dark counts ~ few 100 kHz/mm²
- radiation damage (p,n)







Cosmic ray test scintillation counter MWPC telescope



Results are very promissing.






Photon detectors for the aerogel RICH, summary

BURLE 85011 MPC PMT

- Best understood, beam and bench tested, excellent timing
- Open issues: ageing, read-out for fast timing

Multichannel H(A)PD – R+D with Hamamatsu

- Finally working samples, good progress in read-out electronics
- Open issues: more tests needed, performance in the beam, ageing

SiPM (G-APD)

- Very good first results
- Open issues: radiation hardness



TOP - dispersion

Expected performance with: bi-alkali photocathode: <4σ π/K separation at 4GeV/c (← chromatic dispersion)





with GaAsP photocathode: > $4\sigma \pi/K$ separation at 4GeV/c





| option | K/pi separation performance at 70 deg, 4GeV/c | critical issues |
|-----------------------------|---|--------------------------------|
| 3 readout + multi-alkali | 2.8 sigma | (Make prototype) |
| 3 readout + GaAsP | 3.5 sigma | MCP production MCP lifetime |
| Focusing + multi-alkali | 2.5 sigma \rightarrow 4.0 sigma if CE=60% | MCP lifetime |
| Focusing + GaAsP | 4.2 sigma | MCP production MCP lifetime |

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Focusing DIRC tests at SLAC





Photon detectors: flat pannel PMTs and Burle MCP PMTs, part of it read-out by Gary Varner's wave sampling read-out

March 19, 2008

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Peter Križan, Ljubljana



Buffered Large Analog Bandwidth (BLAB1)

Two Rows of 512 cells

1.4mV

200

180

160

140

120

- Custom Analog-to-Digital (ADC) ٠
- 65 k deep sampling ٠
- High speed sampling ٠
- Low power consumption ٠
- 10 real bits of dynamic range ٠



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0

-2

-4 -6

-18

0

attenuation (dB) -8 -10-12 -14 -16

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Measured Noise

GCK w/

Entries

Mean

RMS

Mean

Sigma

Constan

CMPBIAS

200kohm

1024

1.452

0.1373

 $\textbf{181.6} \pm \textbf{7.6}$

 1.446 ± 0.004

 0.1316 ± 0.0037



Typical single p.e. signal [Burle]



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Beam test data looks good, being analyzed

Plan for the next beam test: equip 7 MCP PMTs with BLAB read-out



PID summary

Aerogel RICH:

- A lot of progress in understanding the photon detectors; more beam/bench tests in spring → decision
- Read-out: still a lot to be done, final choice depends on photon detector (timing or not)

TOP:

- Photon detector with GaAsP photocathode: excellent Q.E. and timing, dark count rate high.
- Plan: study ageing.

Focusing DIRC:

• Promissing beam tests at SLAC, progress in read-out electronics interesting for other devices as well.



More detailed study is going on



Radiation Hardness of ECL Components

I. Nakamura

\Box to γ rays

- dose as of Now ~ 100–400 rad
- Crystals checked @ BINP

| crystal | dose (rad) | # photons |
|-----------|------------|-----------|
| | 100 | ~0.95 |
| CsI(11) | 1000 | ~0.90 |
| CsI(Pure) | 100 | 1.0 |
| | 10000 | 0.9–0.8 |

PD checked @ TIT

| dose (rad) | $\Delta I(\mathbf{n}\mathbf{A})$ | $C_{\rm j}/C_{\rm j0}$ | G/G_0 |
|------------|----------------------------------|------------------------|---------|
| 190 | ~ 0 | 1.0 | 1.00 |
| 610 | ~ 0.2 | 1.0 | 1.00 |
| 6.8k | ~ 1 | 1.0 | 1.00 |
| 70k | ~ 6 | 1.0 | 0.99 |

- \Box γ rays no problem
- some degradation with Neutrons
- Rad. hardness of crystals depend on producer

to Neutrons

- dose as of Now ~ 10^{10} – 10^{11} /cm²
- Test performed @ reactor YAYOI

• PD

| dose (/cm ²) | $\Delta I(nA)$ | $C_{\rm j}/C_{\rm j0}$ | G/G_0 |
|--------------------------|----------------|------------------------|---------|
| 1×10^{11} | ~ 100 | 1 | 1.00 |
| 1×10^{12} | ~ 1000 | 1 | 0.98 |
| 1×10^{13} | ~ 10000 | 1 | 0.93 |

• Crystals

| crystal | dose (/cm ²) | # photons |
|-----------|--------------------------|-----------|
| CsI(Tl)* | 1×10^{12} | ~0.7 |
| CsI(Pure) | 1×10^{12} | 1.0-0.95 |

* small crystal doesn't show degradation



March 12, 2000

CsI read-out status



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Possible options for ECL

Free from Fastbus malfunctions Dead time reduction by factor 3 No background reduction

> Copper 5k\$*100 AMT3 Finesse 200*0.7k\$ Crate 6*5k\$ (Total 0.7 M\$)

Option 1 New readout system

Dead time free BKG reduction by factor 7

Shaper FADC 5k\$*550 (Copper 5k\$*80) (DSP board 1k\$*150) (Crate 5k\$*5) Total 2.8 M\$ Option 2 Pure CsI in end caps

BKG reduction by factor 200

Option 1 + Crystal ~5k\$/ch PMT 1k\$/ch Frontend 1k\$/ch Total 6.2M\$/480ch to 17.6M\$/2112ch

 $\mathsf{PICIUI}_{\mathcal{I}}$

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г стег книган, сјиријана

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ECL Schedule



To start in Oct. 2012

Design decision in October 2008 for crystal and PMT production





KLM Schedule



To start in Oct. 2012

Design decision by March 2009 for end caps, by early 2010 for barrel

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KLM Possible options







K_L Veto Efficiency Dependence







Muons from $ee \rightarrow \mu\mu$ are seen with proper time, proper position









Simulation study



Preliminary Geometry

Regardless of the space, we prepared a geant4 module under the framework of Super Belle simulations. Assuming a <u>silicon pixel detector</u> with large cells: <u>2mm x 2mm</u>. Sensors only at this moment:





ILC forward detectors?



ILC very forward detectors

Role of ILC-forward detectors

- Measurement of luminosity
- Extension of angular coverage
 - > Measurement of missing energy
- Monitor of the beam profile at IP

ILC forward detectors

- LumiCal, BeamCal, Pair monitor, GamCal
- Common R&D elements in all the detector concepts.
- \rightarrow R&D is performed by the ILC-FCAL collaboration.
 - > Organization by14 institutes from 11 countries.

The very-forward detectors are shown on each purpose. (GamCal is not presented in this talk.)

